Figure 3. Pin Configuration (Top View)
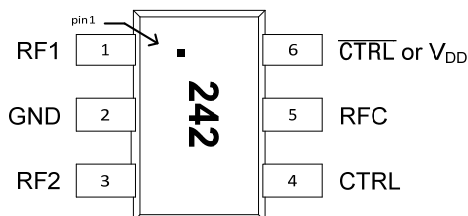

RF1 — pin 1 — 1 | 242 | 6 — $\overline{CTRL}$ or V_{DD}
GND — 2 | | 5 — RFC
RF2 — 3 | | 4 — CTRL

Table 2. Pin Descriptions[1]

Pin No.	Pin Name	Description
1	RF1	RF1 port[2]
2	GND	Ground connection. Traces should be physically short and connected to ground plane for best performance.
3	RF2	RF2 port[1]
4	CTRL	Switch control input, CMOS logic level
5	RFC	Common RF port for switch[1]
6	$\overline{CTRL}$ or V_{DD}	This pin supports two interface options: *Single-pin control mode.* A nominal 3-volt supply connection is required. *Complementary-pin control mode.* A complementary CMOS control signal to CTRL is supplied to this pin. Bypassing on this pin is not required in this mode.

Note: 1. Operation should be restricted to the limits in the Operating Ranges table
2. All RF pins must be DC blocked with an external series capacitor or held at 0 V_{DC}.

Table 3. Absolute Maximum Ratings

Symbol	Parameter/Conditions	Min	Max	Units
V_{DD}	Power supply voltage	-0.3	4.0	V
V_I	Voltage on any input	-0.3	V_{DD}+ 0.3	V
T_{ST}	Storage temperature range	-65	150	°C
T_{OP}	Operating temperature range	-40	85	°C
P_{IN}	Input power (50 Ω)		30	dBm
V_{ESD}[1]	HBM ESD Voltage		1500	V

Note: 1. Human Body Model ESD Voltage (HBM, MIL_STD 883 Method 3015.7)

Exceeding absolute maximum ratings may cause permanent damage. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

Table 4. DC Electrical Specifications

Parameter	Min	Typ	Max	Units
V_{DD} Power Supply Voltage	2.7	3.0	3.3	V
I_{DD} Power Supply Current (V_{DD} = 3 V, V_{CTRL} = 3 V)		250	500	nA
Control Voltage High	0.7x V_{DD}			V
Control Voltage Low			0.3x V_{DD}	V

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

Moisture Sensitivity Level

The Moisture Sensitivity Level rating for the PE4242 in the 6-lead SC-70 package is MSL1.

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Table 5. Single-pin Control Logic Truth Table

Control Voltages	Signal Path
Pin 6 (V_{DD}) = V_{DD} Pin 4 (CTRL) = Low	RFC to RF1
Pin 6 (V_{DD}) = V_{DD} Pin 4 (CTRL) = High	RFC to RF2

Table 6. Complementary-pin Control Logic Truth Table

Control Voltages	Signal Path
Pin 6 ($\overline{CTRL}$ or V_{DD}) = High Pin 4 (CTRL) = Low	RFC to RF1
Pin 6 ($\overline{CTRL}$ or V_{DD}) = Low Pin 4 (CTRL) = High	RFC to RF2

Control Logic Input

The PE4242 is a versatile RF CMOS switch that supports two operating control modes; single-pin control mode and complementary-pin control mode.

Single-pin control mode enables the switch to operate with a single control pin (pin 4) supporting a +3-volt CMOS logic input, and requires a dedicated +3-volt power supply connection on pin 6 (V_{DD}). This mode of operation reduces the number of control lines required and simplifies the switch control interface typically derived from a CMOS μProcessor I/O port.

Complementary-pin control mode allows the switch to operate using complementary control pins CTRL and $\overline{CTRL}$ (pins 4 & 6), that can be directly driven by +3-volt CMOS logic or a suitable μProcessor I/O port. This enables the PE4242 to be used as a potential alternate source for SPDT RF switch products used in positive control voltage mode and operating within the PE4242 operating limits.
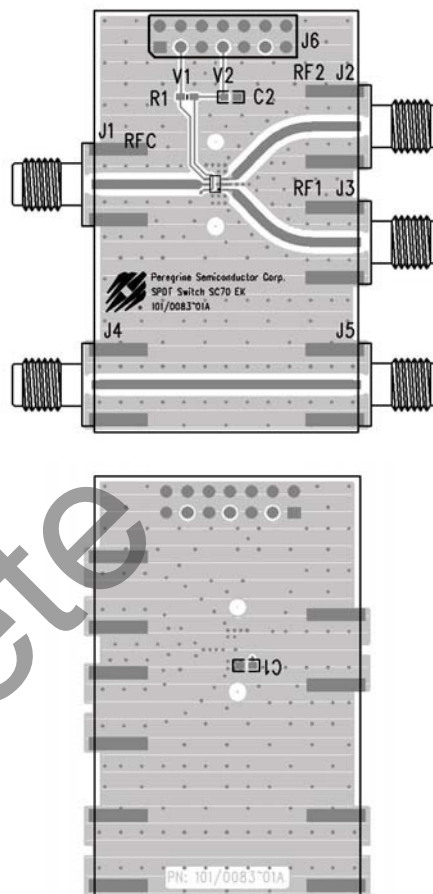
Evaluation Kit

The SPDT Switch Evaluation Kit board was designed to ease customer evaluation of the PE4242 SPDT switch. The RF common port is connected through a 50 Ω transmission line to the top left SMA connector, J1. Port 1 and Port 2 are connected through 50 Ω transmission lines to the top two SMA connectors on the right side of the board, J3 and J2, respectively. A through transmission line connects SMA connectors J4 and J5. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated.

The board is constructed of a two metal layer FR4 material with a total thickness of 0.031". The bottom layer provides ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 0.0476", trace gaps of 0.030", dielectric thickness of 0.028", metal thickness of 0.0021" and ε_r of 4.4.
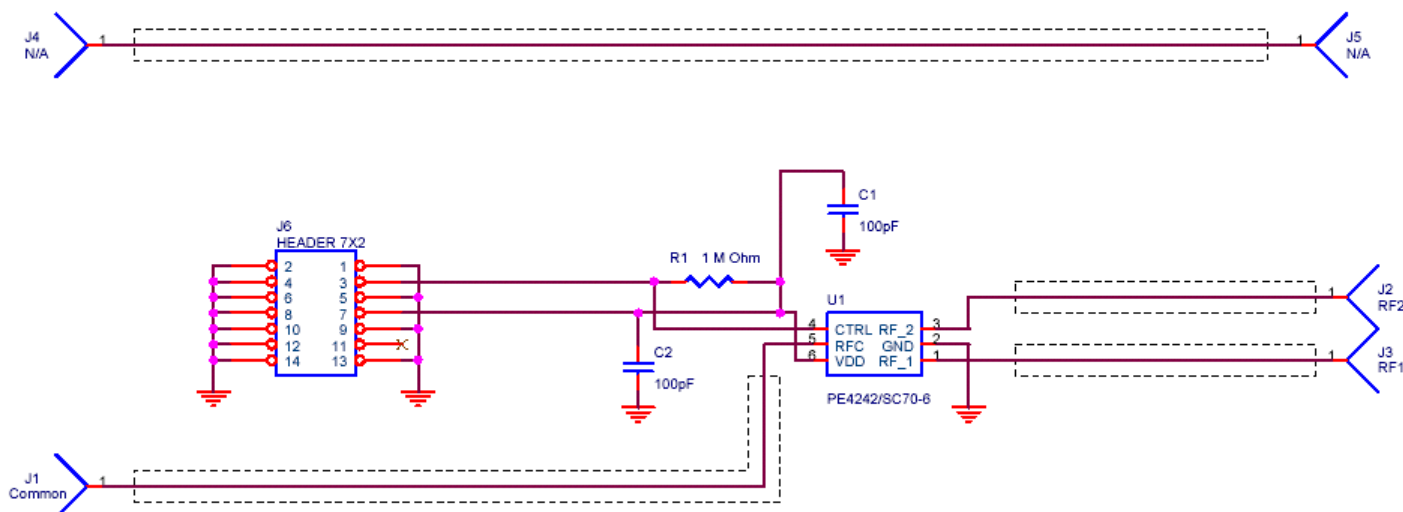
J6 provides a means for controlling DC and digital inputs to the device. Starting from the lower left pin, the second pin to the right (J6-3) is connected to the device V1 or CTRL input. The fourth pin to the right (J6-7) is connected to the device V2 or $\overline{CTRL}/V_{DD}$ input.
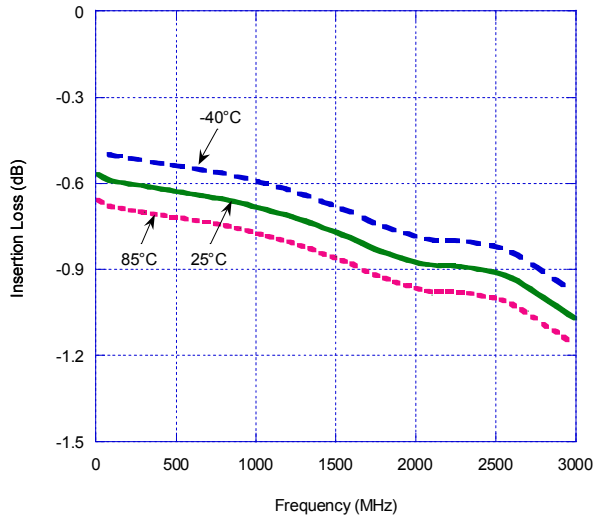
Figure 4. Evaluation Board Layout

101/0083

Figure 5. Evaluation Board Schematic

102/0145

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Typical Performance Data @ -40 °C to 85 °C (Unless otherwise noted)

Figure 6. Insertion Loss – RFC to RF1

Figure 7. Input 1 dB Compression Point & IIP3
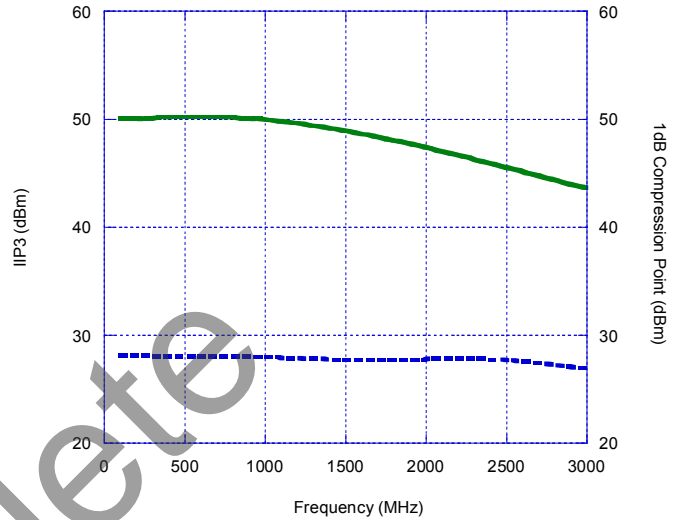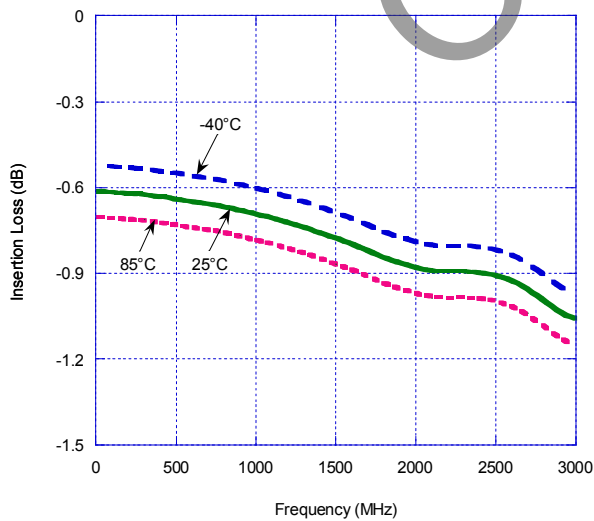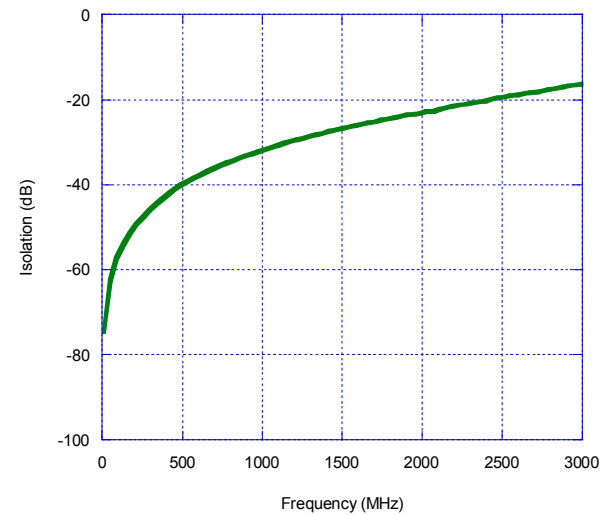**(Typical Performance @ 25 °C)**

Figure 8. Insertion Loss – RFC to RF2

Figure 9. Isolation – RFC to RF1
(Typical Performance @ 25 °C)

Typical Performance Data @ 25°C

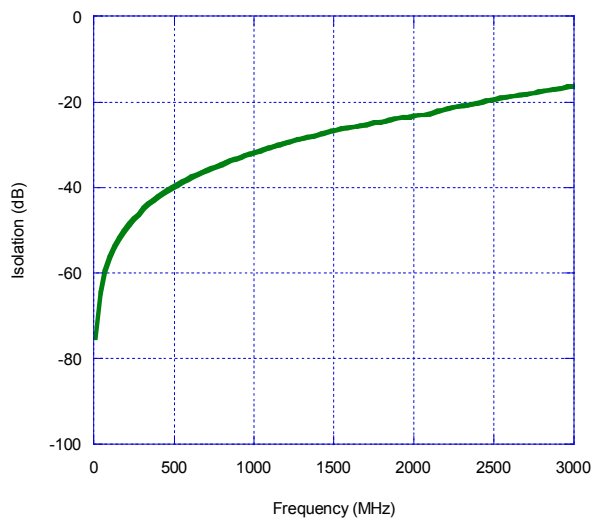**Figure 10. Isolation – RFC to RF2**

Figure 11. Isolation – RF1 to RF2, RF2 to RF1

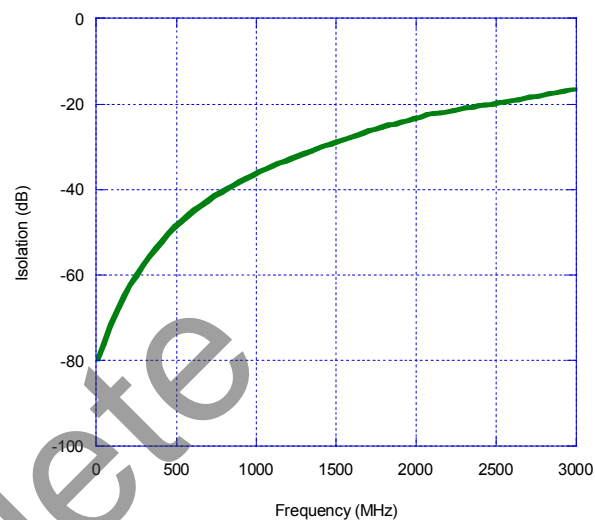**Figure 12. Return Loss – RFC to RF1, RF2**
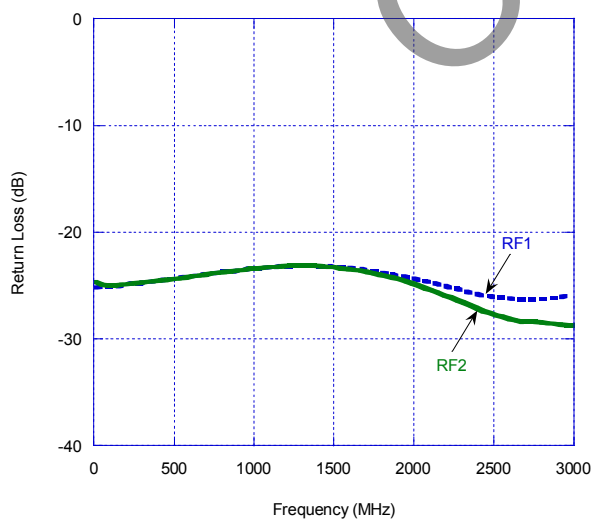
Figure 13. Return Loss – RF1, RF2

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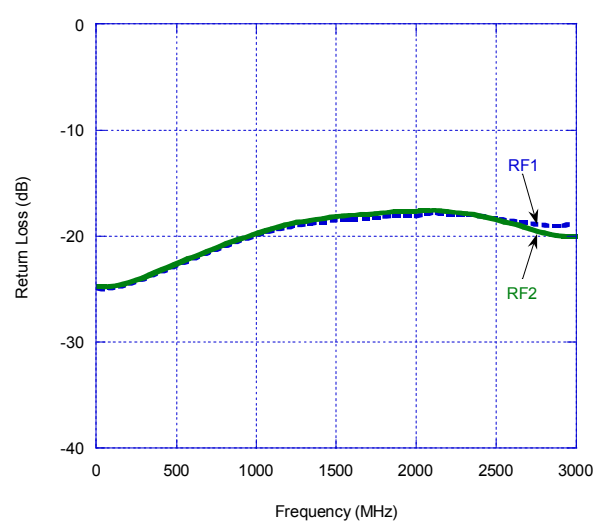
Figure 14. Package Drawing

6-lead SC-70

NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS
2. DIMENSIONS ARE INCLUSIVE OF PLATING
3. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH & METAL BURR
4. ALL SPECIFICATIONS COMPLY TO EIAJ SC70
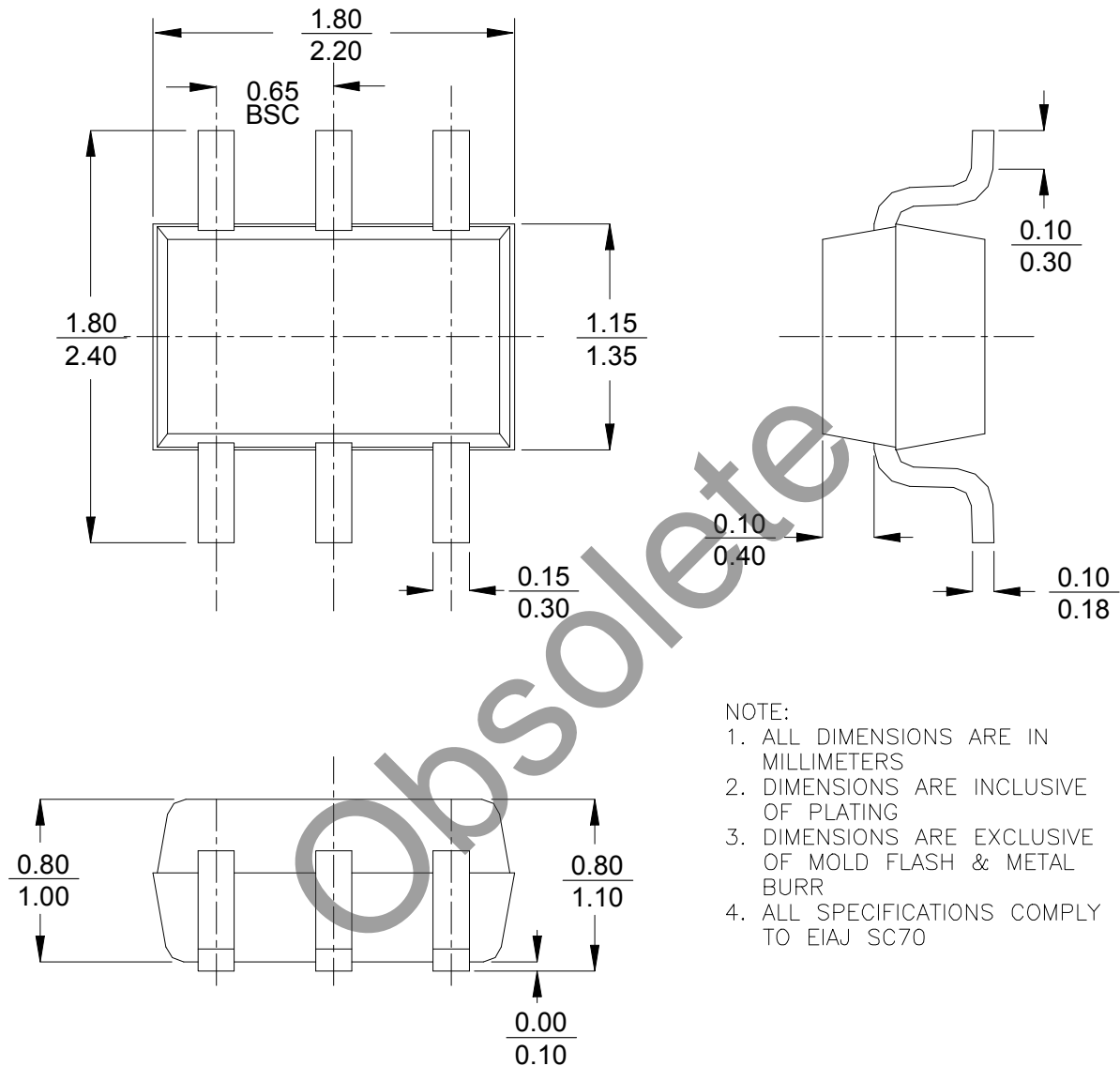
Figure 15. Tape and Reel Specifications

Section A-A

Pin 1

- - - - - - - ► Tape Feed Direction - - - - - - - - ►

	Nominal	Tolerance
Ao	2.25	±0.05
Bo	2.40	±0.05
Ko	1.20	±0.05

Device Orientation in Tape

Notes: 10 sprocket hole pitch cumulative tolerance ±0.02
Camber not to exceed 1 mm in 100 mm
Material: Black Conductive Advantek Polystyrene
Ao and Bo measured on a plane 0.3 mm above the bottom of the pocket
Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier
Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole

Table 7. Ordering Information

Order Code	Part Marking	Description	Package	Shipping Method
4242-00	PE4242-EK	PE4242-06SC70-EK	Evaluation Kit	1 / Box
4242-52	242	PE4242G-06SC70-3000C	Green 6-lead SC-70	3000 units / T&R

Sales Contact and Information

For Sales and contact information please visit www.psemi.com.

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